VNP-29MC-M/C 5

Integrating Thermoelectric Peltier Cooled into Nano Stage Pixel Shifting Camera



CAMERA

VNP Series, pixel shifting camera equipped with thermo–electric Peltier (TEC) cooled, is designed not only for applications where extremely high resolution is required but also where high quality image is essential. The TEC maintains the operating temperature of the CCD at up to 15 degrees below ambient temperature to reduce noise significantly. Pixel shifting technology based on a precise piezoelectric stage allows image captures as high as 260 million pixels using the VNP–29MC cameras.

These cameras are ideal for applications such as FPD inspection, document/film scanning, research and scientific imaging.



Main Features

- Nano Stage Pixel Shifting Mechanism
- Thermoelectric Peltier Cooled
- Extended Resolutions up to 260 Megapixels
- True Color Full Image Resolution
- Improved Fill Factor
- Progressive Scan Interline Transfer CCD Imager
- Flat Field Correction / Pixel Defect Correction

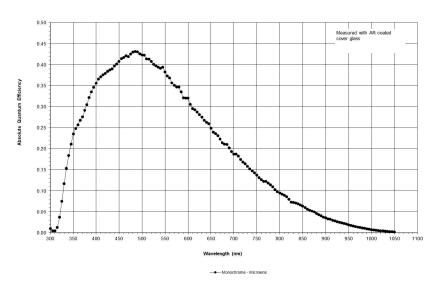
Applications

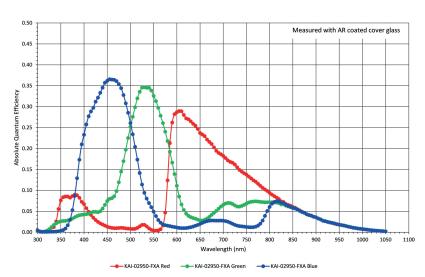
- Flat Panel Display Inspection
- Electronics and Semiconductor Inspection
- Digitizing and Scanning
- Scientific Imaging

Specifications

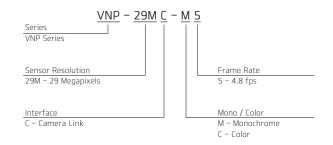
Model		VNP-29MC-M/C 5		
Deselvations	×1 Mode	6576 × 4384, 28.8M		
Resolution (H × V)	×4 Mode	13152 × 8768, 115.3M		
(11 * * * *)	×9 Mode	19728 × 13152, 259.5M		
Sensor	r	ON Semiconductor KAI-29050		
Sensor Size(Optical Format)		$36.17 \text{ mm} \times 24.11 \text{ mm} (35 \text{ mm})$		
Sensor Type		Progressive Scan Interline Transfer CCD		
Pixel Size		5.5 μ m $ imes$ 5.5 μ m		
Interface		Camera Link		
Max. Frame	×1 Mode	4.8 fps		
Rate	×4 Mode	1.2 fps		
(40 MHz)	×9 Mode	0.5 fps		
Exposure Time (10 µs step)		1/100000 s - 7 s		
Partial Scan (Max. Speed)		15.2 fps at 1000 Lines		
Pixel Data Format		8 / 10 / 12 bit		
Electronic Shutter		Global Shutter		
Data Output Pixel Clock		40/80 MHz		
Trigger Mode		Free-Run, Overlap, Fast, Double – Programmable Exposure Time and Trigger Polarity		
Dynamic Range		62 dB		
Shift Range		$0\sim15~\mu\mathrm{m}$, 1 nm step		
Shift Resolution		0.001 μm		
Shift Con	trol	Manual Mode or Sequence Mode (4/9 Shot Mono, 4/16/36 Shot Color)		
Shift Late	ency	< 8 ms		
Cooling Me	ethod	Thermoelectric Peltier Cooling		
Cooling Perfo	rmance	15℃ below ambient temperature – Standard cooling with a fan		
Dimension /	Weight	94 mm $ imes$ 120 mm $ imes$ 183.9 mm, 2.3 kg		
Temperat	ture	Operating: 10°C ~ 40°C, Storage: −40°C ~ 70°C		
Lens Mount		F-mount, Custom mount available upon request		
Power		10~14 V DC, Typ. 26.5 W		
Compliance		CE, FCC, KC		
Configuration	Software	Configurator		

Quantum Efficiency Curves





Ordering Scheme



Connector Specification



1, 2, 3: +12V DC 4, 5, 6: GND (HR10A-7R-6PB)

Control

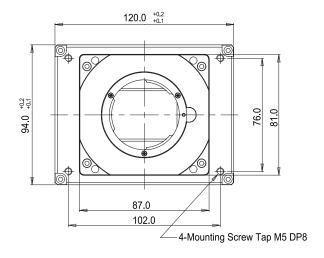


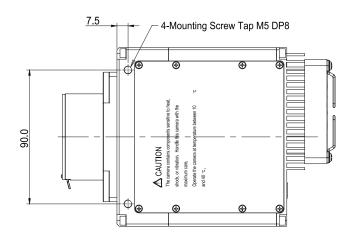
1: Trigger IN+ 2: Trigger IN-3: Strobe OUT-(GND) 4: Strobe OUT+ (HR10A-7R-4S)

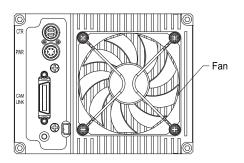
Connectors on camera body

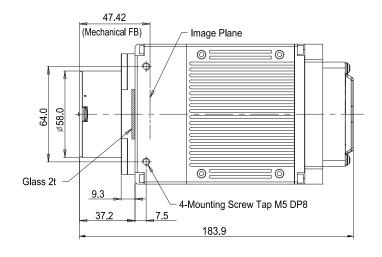
Mechanical Dimensions

Unit: mm









For more information please contact:



BOCK OPTRONICS INC. 14 Steinway Blvd., Unit 7

14 Steinway Blvd., Unit 7 Toronto, Ontario M9W 6M6

Tel: (416) 674-2804 sales@bockoptronics.ca www.bockoptronics.ca



VNP-604MX-M/C 6 H

604 Megapixel Pixel Shifting Camera Equipped with Thermoelectric Peltier



The VNP-604MX-6 H, a pixel shifting camera equipped with thermo-electric Peltier (TEC) cooled, is designed not only for applications where extremely high resolution is required but also where high quality image is essential. The TEC maintains the operating temperature of the image sensor at up to $15\pm2^{\circ}$ C below ambient temperature to reduce noise significantly. Pixel shifting technology based on a precise piezoelectric stage allows image captures as high as 604 million pixels at 1.5 fps. The CoaXPress interface adopted by this camera supports transmitting image data at up to 25 Gbps using four coaxial cables. This new camera delivers unique and unparalleled performance in the most demanding applications such as FPD, PCB and semiconductor inspections.



Main Features

- Nano Stage Pixel Shifting Mechanism
- Thermoelectric Peltier Cooled 15±2℃ below
- Extended Resolutions up to 1,359 MP
- CoaXPress Interface
- Electronic Rolling Shutter
- DSNU and PRNU Correction
- Flat Field Correction with Sequencer Control
- Hot Pixel Correction
- Dynamic Defective Pixel Correction

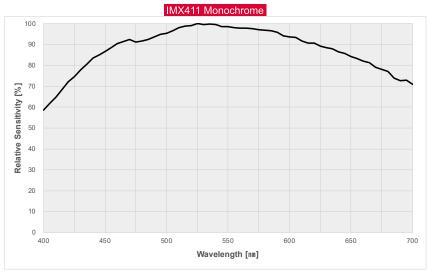
Applications

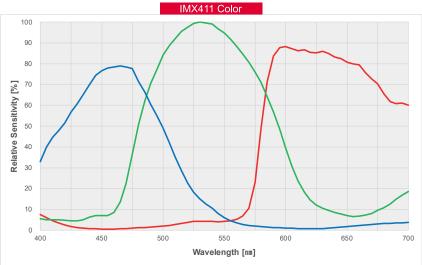
- Flat Panel Display Inspection
- Electronics Inspection
- Semiconductor Inspection
- Document / Film Scanning

Specifications

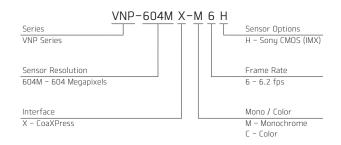
•				
	Model	VNP-604MX-M/C 6 H		
Resolution (H×V)	1× (1 Shot)	14192 × 10640		
Resolution (n \ v)	4× (4 Shot)	28384 × 21280		
	Sensor	SONY IMX411		
Senso	r Size (Diagonal)	53.36 mm $ imes$ 40.01 mm (66.7 mm)		
	Pixel Size	$3.76~\mu\mathrm{m}~ imes~3.76~\mu\mathrm{m}$		
	Interface	CoaXPress		
Max. Frame Rate	1× Mode	6.2 fps (with Overlapped Acquisition)		
	4× Mode	1.5 fps (with Overlapped Acquisition)		
Exposur	re Time (1 μs step)	1 μs - 60 s		
Partial	Scan (Max. Speed)	546.4 fps at 2 Lines (12 bit)		
Pixel Data Format	Mono	Mono 8 / Mono 10 / Mono 12		
	Color	RG Bayer 8 / RG Bayer 10 / RG Bayer 12		
Elec	tronic Shutter	Rolling Shutter		
Trigger	Overlapped Acquisition	Free-Run		
Synchronization	Non-overlapped Acquisition	Hardware Trigger, Software Trigger or CXP		
Dy	namic Range	78 dB		
G	ain Control	1×~32×		
Blac	k Level Control	0 ~ 255 LSB at 12 bit		
Ç	Shift Range	0 ~ 15 μm, 1 nm step		
Shi	ift Resolution	0.001 μm		
S	hift Control	Manual Mode or Sequence Mode (4/9 Shot Mono, 4/16/36 Shot Color)		
S	hift Latency	< 5 ms		
Со	oling Method	Thermoelectric Peltier Cooling		
Coolir	ng Performance	15 \pm 2 $^{\circ}$ C below ambient temperature − Standard cooling with a fan		
Dime	ension / Weight	110 mm $ imes$ 110 mm $ imes$ 134 mm, 2.5 kg (with M-72 mount)		
Т	emperature	Operating: 0°C ~ 40°C, Storage: −40°C ~ 70°C		
l	ens Mount	M72-mount, Custom mount available upon request		
D	External	11 ~ 24 V DC		
Power	Dissipation	Typ. 31.0 W		
(Compliance	CE, FCC, KC		
	API SDK	Vieworks Imaging Solution 7.X		

Spectral Response





Ordering Scheme



Connector Specification

Power



1, 2, 3: +12 V DC 4, 5, 6: GND (HR10A-7R-6PB)

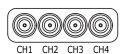
Control



1: Trigger IN+ 2: Trigger IN-3: Strobe Out-(GND)

4: Strobe Out+ (HR10A-7R-4S)

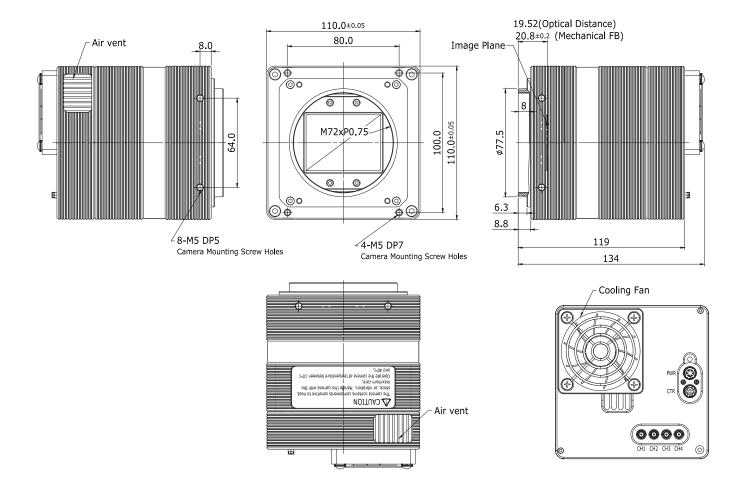
Data Transfer / Communications



CH1: Master Connection 75 Ω , DIN 1.0/2.3

Mechanical Dimensions

Unit: mm



For more information please contact:



BOCK OPTRONICS INC. 14 Steinway Blvd., Unit 7

Toronto, Ontario M9W 6M6

Tel: (416) 674-2804 sales@bockoptronics.ca www.bockoptronics.ca

VNP-200MX

200 MEGAPIXEL PIXEL SHIFTING CAMERA EQUIPPED WITH THERMOELECTRIC PELTIER





The VNP–200MX, a pixel shifting camera equipped with thermo–electric Peltier (TEC) cooled, is designed not only for applications where extremely high resolution is required but also where high quality image is essential. The TEC maintains the operating temperature of the image sensor at up to 10 degrees below ambient temperature to reduce noise significantly. Pixel shifting technology based on a precise piezoelectric stage allows image captures as high as 427 million pixels using the VNP–200MX camera. Its CoaXPress interface supports transmitting image data at up to 25 Gbps using four coaxial cables. This camera is ideal for applications such as FPD inspection, document / film scanning, research and scientific imaging.



Main Features

- * 50 Megapixel Resolution (AMS CMOSIS)
- * Nano Stage Pixel Shifting Mechanism
- * Extended Resolution up to 427 MP at 3 fps (9 Shot Mode)
- * Thermoelectric Peltier Cooling
- * CoaXPress Interface up to 30 fps at 25 Gbps using 4 CH
- * Pixel Defect Correction
- * Flat Field Correction
- * DSNU and PRNU Correction

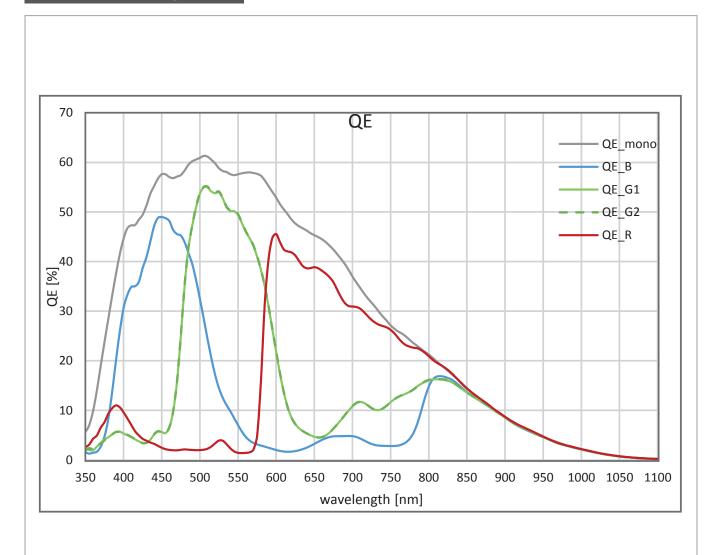
Applications

- * FPD and PCB Inspection
- * Semiconductor Inspection
- * High Speed 3D Imaging
- * Digitizing and Scanning
- * Research and Scientific Imaging

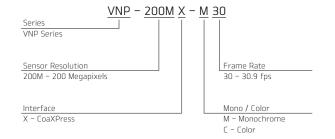
Specifications

Model			VNP-200MX-M/C 30		
Resolution (H × V)		7920 × 6004			
Sensor		AMS CMOSIS CMV 50000			
Sensor Size		36.43 mm × 27.62 mm (Diagonal: 45.72 mm, Optical Format: 35 mm)			
Sensor Type		High Speed CMOS Image Sensor			
Pixel Size		4.6 μm × 4.6 μm			
Interface		CoaXPress			
Max. Frame Rate	47.5 MP	1CH: 7.7 fps @ 6.25 Gbps	2CH: 15.5 fps @ 6.25 Gbps	4CH: 30.9 fps @ 6.25 Gbps	
	190 MP	1CH: 2 fps @ 6.25 Gbps	2CH: 3.9 fps @ 6.25 Gbps	4CH: 7.7 fps @ 6.25 Gbps	
	427 MP	1CH: 1 fps @ 6.25 Gbps	2CH: 1.7 fps @ 6.25 Gbps	4CH: 3.4 fps @ 6.25 Gbps	
Exposure Time (1 µs step)		1 μs - 60 s			
Partial Scan (Max. Speed)		3968 fps at 4 Lines			
Divisi Data Farmant	Mono	Mono 8 / Mono 10 / Mono 12			
Pixel Data Format	Color	BG Bayer 8 / BG Bayer 10 / BG Bayer 12			
Electronic Shutter		Global Shutter			
Exposure Mode		Free-Run, Timed and Trigger Width			
Dynamic Range		64 dB			
Gain Control		1× ~ 30× (1/1024 step)			
Black Level Control		0 ~ 256 LSB at 12 bit (1 LSB step)			
Shift Range		0 ~ 7.5 μm, 1 nm step			
Shift Resolution		0.001 μm			
Shift Cont	rol	Sequence Mode (mono4, mono9, mono2H, mono2V, bayer4, bayer16)			
Cooling Met	thod	Thermoelectric Peltier Cooling			
Cooling Performance		10℃ below ambient temperature / Standard cooling with a fan			
Dimension / Weight		90 mm $ imes$ 90 mm $ imes$ 191 mm, 1,920 g			
Temperature		Operating: -5°C ~ 40°C, Storage: -40°C ~ 70°C			
Lens Mount		F-mount, Custom mount available upon request			
D.	External	10 ~ 24 V DC, Typ. 26.0 W			
Power	PoCXP	Not supported			
Compliance		CE, FCC, KC			
API SDK		Vieworks Imaging Solution 7.X			

Quantum Efficiency Curves



Ordering Scheme



Connector Specification

Power



1 2 3: +12V DC, 4 5 6: GND (HR10A-7R-6PB)

Control



1: Trigger IN+, 2: Trigger IN-3: Strobe Out-(GND), 4: Strobe OUT+ (HR10A-7R-4S)

Data Transfer / Communications

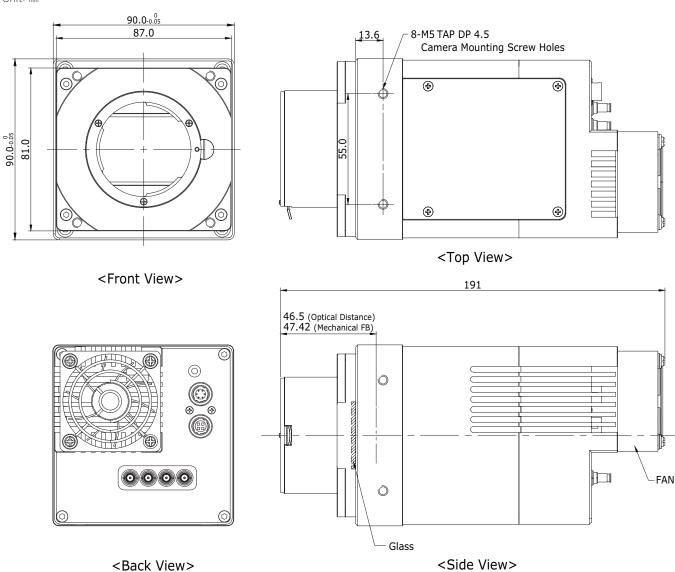


CH1: Master Connection (75 Ω, DIN 1.0/2.3)

Connectors on camera body

Mechanical Dimensions

Unit: mm



For more information please contact local distributor or visit our website at http://www.vieworks.com.

Reproduction in whole or in part without written permission is prohibited. Vieworks Co., Ltd. is not responsible for any technical or typographical errors and reserves the right to make changes to products, specifications and documentation without prior notice.

D-18-206



For more information please contact:

BOCK OPTRONICS INC.

14 Steinway Blvd., Unit 7 Toronto, Ontario M9W 6M6

Tel: (416) 674-2804 sales@bockoptronics.ca www.bockoptronics.ca

VIEWORKS

VNP-190MX

190 MEGAPIXEL PIXEL SHIFTING CAMERA EQUIPPED WITH THERMOELECTRIC PELTIER



The VNP-190MX, a pixel shifting camera equipped with thermo-electric Peltier (TEC) cooled, is designed not only for applications where extremely high resolution is required but also where high quality image is essential. The TEC maintains the operating temperature of the image sensor at up to 14 degrees below ambient temperature to reduce noise significantly. Pixel shifting technology based on a precise piezoelectric stage allows image captures as high as 420 million pixels using the VNP-190MX camera. Its CoaXPress interface supports transmitting image data at up to 12.5 Gbps using two coaxial cables. This camera is ideal for applications such as FPD inspection, document / film scanning, research and scientific imaging.

